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7/24/DE

UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

S/N 09

Joseph E. Geusic et al.

Examiner: Julio Maldonado

Serial No.:

09/650,569

Group Art Unit: 2823

Filed:

JUL 0 8 2002

August 30, 2000

Docket: 303.390US3

Title:

METHOD OF FORMING AN OPTICAL FIBER INTERCONNECT THROUGH

A SEMICONDUCTOR WAFER

### AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Commissioner for Patents Washington, D.C. 20231

Applicant has reviewed the Office Action mailed on April 2, 2002. Please amenesthe above-identified patent application as follows.

IN THE SPECIFICATION

Please make the paragraph substitutions indicated in the appendix entitled Clear Version and Specification Paragraphs. The specification of Amended Specification Paragraphs. The specific changes incorporated in the substitute paragraphs are shown in the following marked-up versions of the original paragraphs:

# Paragraph 1 on page 1 is amended as follows:

This application is a Continuation of U.S. application, Serial No. 09/031,975, filed on February 26, 1998, now U.S. Patent No. 6,150,188.

## **REMARKS**

Applicant has carefully reviewed and considered the Office Action mailed on April 2, 2002, and the references cited therewith.

Claims 39-72 are pending in this application.

## Information Disclosure Statement

Applicant respectfully requests that copies of the 1449 Forms, listing all references that were submitted with the Supplemental Information Disclosure Statements filed on November 13, 2001 and March 18, 2002, marked as being considered and initialed by the Examiner, be returned with the next official communication.